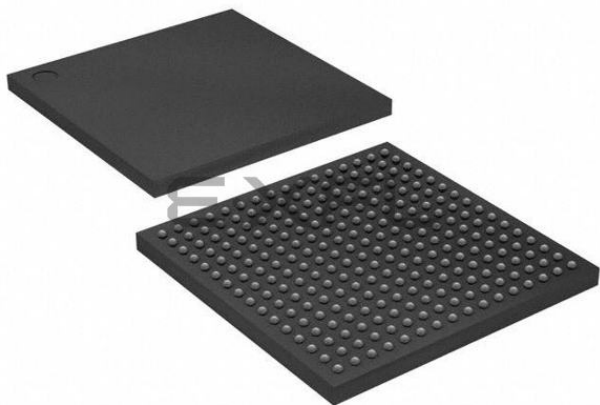




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Understanding **Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	384
Number of Logic Elements/Cells	-
Total RAM Bits	442368
Number of I/O	172
Number of Gates	250000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v250-4fgg256i

Revision History

This section records the change history for this module of the data sheet.

Date	Version	Revision
11/07/00	1.0	Early access draft.
12/06/00	1.1	Initial release.
01/15/01	1.2	Added values to the tables in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics sections.
01/25/01	1.3	The data sheet was divided into four modules (per the current style standard).
04/02/01	1.5	Skipped v1.4 to sync up modules. Reverted to traditional double-column format.
07/30/01	1.6	Made minor changes to items listed under Summary of Virtex-II™ Features .
10/02/01	1.7	Minor edits.
07/16/02	1.8	Updated Virtex-II Device/Package Combinations shown in Table 6 .
09/26/02	1.9	Updated Table 2 and Table 6 to reflect supported Virtex-II Device/Package Combinations.
08/01/03	2.0	All Virtex-II devices and speed grades now Production. See Table 13, Module 3.
03/29/04	2.0.1	Recompiled for backward compatibility with Acrobat 4 and above. No content changes.
06/24/04	3.3	Added references to available Pb-free wire-bond packages. (Revision number advanced to level of complete data sheet.)
03/01/05	3.4	<i>No changes in Module 1 for this revision.</i>
11/05/07	3.5	Updated copyright notice and legal disclaimer.

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Virtex-II Data Sheet

The Virtex-II Data Sheet contains the following modules:

- **Virtex-II Platform FPGAs: Introduction and Overview (Module 1)**
- **Virtex-II Platform FPGAs: Functional Description (Module 2)**
- **Virtex-II Platform FPGAs: DC and Switching Characteristics (Module 3)**
- **Virtex-II Platform FPGAs: Pinout Information (Module 4)**

Table 8: SelectI/O-Ultra Differential Buffers With On-Chip Termination

I/O Standard Description	IOSTANDARD Attribute	
	External Termination	On-Chip Termination
LVDS 2.5V	LVDS_25	LVDS_25_DCI
LVDS Extended 2.5V	LVDSEXT_25	LVDSEXT_25_DCI

Figure 11 provides examples illustrating the use of the HSTL_I_DCI, HSTL_II_DCI, HSTL_III_DCI, and HSTL_IV_DCI I/O standards. For a complete list, see the [Virtex-II Platform FPGA User Guide](#).

	HSTL_I	HSTL_II	HSTL_III	HSTL_IV
Conventional				
DCI Transmit Conventional Receive				
Conventional Transmit DCI Receive				
DCI Transmit DCI Receive				
Bidirectional	N/A		N/A	
Reference Resistor	VRN = VRP = R = Z0	VRN = VRP = R = Z0	VRN = VRP = R = Z0	VRN = VRP = R = Z0
Recommended Z0 ⁽¹⁾	50 Ω	50 Ω	50 Ω	50 Ω

Note:

1. Z0 is the recommended PCB trace impedance.

DS031_65a_100201

Figure 11: HSTL DCI Usage Examples

Figure 18, Figure 19, and Figure 20 illustrate various example configurations.

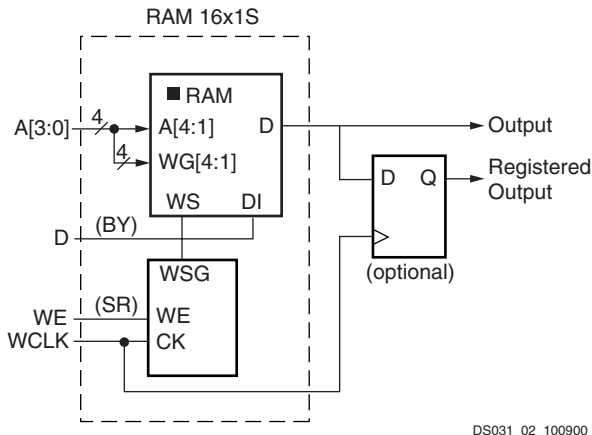


Figure 18: Distributed SelectRAM (RAM16x1S)

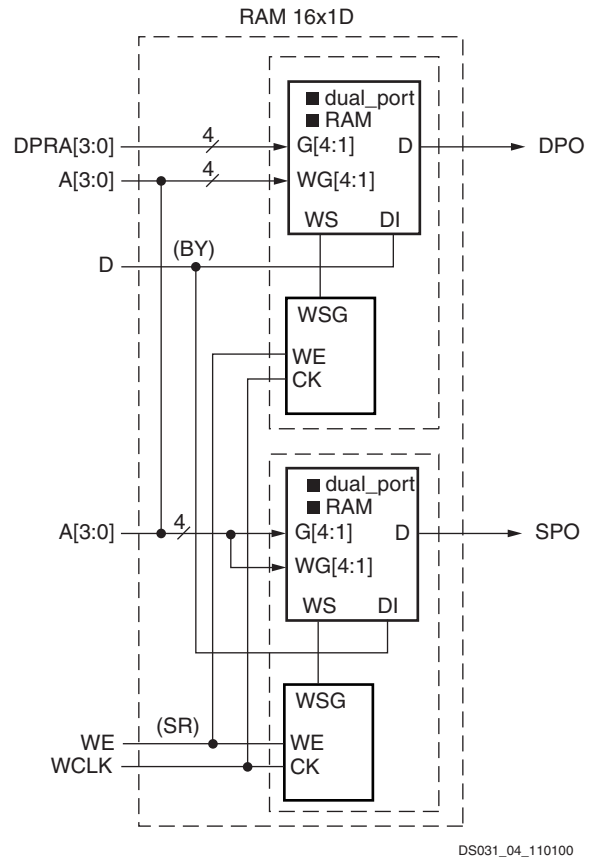


Figure 20: Dual-Port Distributed SelectRAM (RAM16x1D)

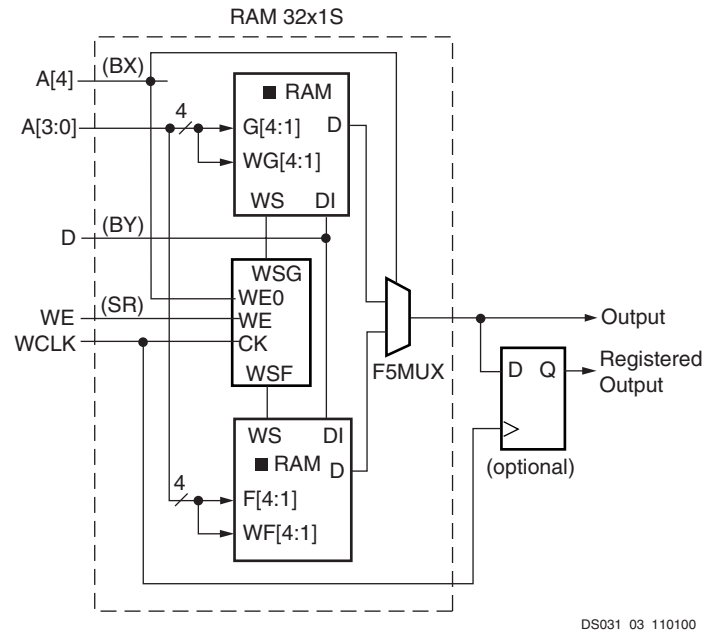


Figure 19: Single-Port Distributed SelectRAM (RAM32x1S)

Similar to the RAM configuration, each function generator (LUT) can implement a 16 x 1-bit ROM. Five configurations are available: ROM16x1, ROM32x1, ROM64x1, ROM128x1, and ROM256x1. The ROM elements are cascadable to implement wider or/and deeper ROM. ROM contents are loaded at configuration. Table 10 shows the number of LUTs occupied by each configuration.

Table 10: ROM Configuration

ROM	Number of LUTs
16 x 1	1
32 x 1	2
64 x 1	4
128 x 1	8 (1 CLB)
256 x 1	16 (2 CLBs)

Extended LVDS DC Specifications (LVDSEXT_33 & LVDSEXT_25)

Table 9: Extended LVDS DC Specifications

DC Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage	V_{CCO}			3.3 or 2.5		V
Output High voltage for Q and $\bar{Q}$	V_{OH}	$R_T = 100\ \Omega$ across Q and $\bar{Q}$ signals			1.785	V
Output Low voltage for Q and $\bar{Q}$	V_{OL}	$R_T = 100\ \Omega$ across Q and $\bar{Q}$ signals	0.705			V
Differential output voltage (Q – $\bar{Q}$), Q = High ($\bar{Q}$ – Q), $\bar{Q}$ = High	V_{ODIFF}	$R_T = 100\ \Omega$ across Q and $\bar{Q}$ signals	440		820	mV
Output common-mode voltage	V_{OCM}	$R_T = 100\ \Omega$ across Q and $\bar{Q}$ signals	1.125	1.200	1.375	V
Differential input voltage (Q – $\bar{Q}$), Q = High ($\bar{Q}$ – Q), $\bar{Q}$ = High	V_{IDIFF}	Common-mode input voltage = 1.25 V	100	350	N/A	mV
Input common-mode voltage	V_{ICM}	Differential input voltage = ± 350 mV	0.2	1.25	$V_{CCO} - 0.5$	V

LVPECL DC Specifications

These values are valid when driving a $100\ \Omega$ differential load only, i.e., a $100\ \Omega$ resistor between the two receiver pins. The V_{OH} levels are 200 mV below standard LVPECL levels and are compatible with devices tolerant of lower

common-mode ranges. Table 10 summarizes the DC output specifications of LVPECL. For more information on using LVPECL, see the *Virtex-II User Guide*.

Table 10: LVPECL DC Specifications

DC Parameter	Min	Max	Min	Max	Min	Max	Units
V_{CCO}	3.0		3.3		3.6		V
V_{OH}	1.8	2.11	1.92	2.28	2.13	2.41	V
V_{OL}	0.96	1.27	1.06	1.43	1.30	1.57	V
V_{IH}	1.49	2.72	1.49	2.72	1.49	2.72	V
V_{IL}	0.86	2.125	0.86	2.125	0.86	2.125	V
Differential Input Voltage	0.3	–	0.3	–	0.3	–	V

Table 17: IOB Output Switching Characteristics Standard Adjustments (Continued)

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
LVC MOS, 2.5V, Fast, 16 mA	LVC MOS25_F16	T _{OLVCMOS25_F16}	-0.18	-0.19	-0.21	ns
LVC MOS, 2.5V, Fast, 24 mA	LVC MOS25_F24	T _{OLVCMOS25_F24}	-0.35	-0.36	-0.40	ns
LVC MOS, 1.8V, Slow, 2 mA	LVC MOS18_S2	T _{OLVCMOS18_S2}	15.62	16.10	17.71	ns
LVC MOS, 1.8V, Slow, 4 mA	LVC MOS18_S4	T _{OLVCMOS18_S4}	10.20	10.51	11.57	ns
LVC MOS, 1.8V, Slow, 6 mA	LVC MOS18_S6	T _{OLVCMOS18_S6}	7.52	7.75	8.53	ns
LVC MOS, 1.8V, Slow, 8 mA	LVC MOS18_S8	T _{OLVCMOS18_S8}	6.87	7.08	7.78	ns
LVC MOS, 1.8V, Slow, 12 mA	LVC MOS18_S12	T _{OLVCMOS18_S12}	5.54	5.71	6.28	ns
LVC MOS, 1.8V, Slow, 16 mA	LVC MOS18_S16	T _{OLVCMOS18_S16}	5.31	5.47	6.02	ns
LVC MOS, 1.8V, Fast, 2 mA	LVC MOS18_F2	T _{OLVCMOS18_F2}	5.55	5.72	6.30	ns
LVC MOS, 1.8V, Fast, 4 mA	LVC MOS18_F4	T _{OLVCMOS18_F4}	1.89	1.95	2.15	ns
LVC MOS, 1.8V, Fast, 6 mA	LVC MOS18_F6	T _{OLVCMOS18_F6}	0.83	0.85	0.94	ns
LVC MOS, 1.8V, Fast, 8 mA	LVC MOS18_F8	T _{OLVCMOS18_F8}	0.70	0.72	0.80	ns
LVC MOS, 1.8V, Fast, 12 mA	LVC MOS18_F12	T _{OLVCMOS18_F12}	0.26	0.27	0.30	ns
LVC MOS, 1.8V, Fast, 16 mA	LVC MOS18_F16	T _{OLVCMOS18_F16}	0.23	0.23	0.26	ns
LVC MOS, 1.5V, Slow, 2 mA	LVC MOS15_S2	T _{OLVCMOS15_S2}	18.96	19.55	21.50	ns
LVC MOS, 1.5V, Slow, 4 mA	LVC MOS15_S4	T _{OLVCMOS15_S4}	12.77	13.17	14.48	ns
LVC MOS, 1.5V, Slow, 6 mA	LVC MOS15_S6	T _{OLVCMOS15_S6}	12.05	12.42	13.66	ns
LVC MOS, 1.5V, Slow, 8 mA	LVC MOS15_S8	T _{OLVCMOS15_S8}	9.75	10.06	11.06	ns
LVC MOS, 1.5V, Slow, 12 mA	LVC MOS15_S12	T _{OLVCMOS15_S12}	9.04	9.32	10.25	ns
LVC MOS, 1.5V, Slow, 16 mA	LVC MOS15_S16	T _{OLVCMOS15_S16}	8.21	8.46	9.31	ns
LVC MOS, 1.5V, Fast, 2 mA	LVC MOS15_F2	T _{OLVCMOS15_F2}	5.09	5.25	5.78	ns
LVC MOS, 1.5V, Fast, 4 mA	LVC MOS15_F4	T _{OLVCMOS15_F4}	2.01	2.07	2.27	ns
LVC MOS, 1.5V, Fast, 6 mA	LVC MOS15_F6	T _{OLVCMOS15_F6}	1.46	1.51	1.66	ns
LVC MOS, 1.5V, Fast, 8 mA	LVC MOS15_F8	T _{OLVCMOS15_F8}	0.93	0.96	1.05	ns
LVC MOS, 1.5V, Fast, 12 mA	LVC MOS15_F12	T _{OLVCMOS15_F12}	0.74	0.77	0.84	ns
LVC MOS, 1.5V, Fast, 16 mA	LVC MOS15_F16	T _{OLVCMOS15_F16}	0.67	0.69	0.75	ns
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	T _{OLVDS_25}	-0.31	-0.32	-0.36	ns
LVDS, 3.3V	LVDS_33	T _{OLVDS_33}	-0.25	-0.26	-0.29	ns
LVDSEXT (LVDS Extended Mode), 2.5V	LVDSEXT_25	T _{OLVDSEXT_25}	-0.18	-0.19	-0.21	ns
LVDSEXT, 3.3V	LVDSEXT_33	T _{OLVDSEXT_33}	-0.17	-0.18	-0.19	ns
ULVDS (Ultra LVDS), 2.5V	ULVDS_25	T _{OLVDS_25}	-0.20	-0.21	-0.23	ns
BLVDS (Bus LVDS), 2.5V	BLVDS_25	T _{OBLVDS_25}	0.67	0.69	0.76	ns
LDT (HyperTransport), 2.5V	LDT_25	T _{OLDT_25}	-0.20	-0.21	-0.23	ns
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	T _{OLVPECL_33}	0.29	0.30	0.33	ns
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3	T _{OPCI33_3}	1.15	1.19	1.31	ns
PCI, 66 MHz, 3.3V	PCI66_3	T _{OPCI66_3}	-0.01	-0.01	-0.01	ns
PCI-X, 133 MHz, 3.3V	PCIX	T _{OPCIX}	-0.01	-0.01	-0.01	ns
GTL (Gunning Transceiver Logic)	GTL	T _{OGTL}	-0.31	-0.32	-0.36	ns
GTL Plus	GTL P	T _{OGTLP}	-0.17	-0.18	-0.20	ns
HSTL (High-Speed Transceiver Logic), Class I	HSTL_I	T _{OHSTL_I}	0.26	0.27	0.29	ns
HSTL, Class II	HSTL_II	T _{OHSTL_II}	-0.15	-0.16	-0.17	ns
HSTL, Class III	HSTL_III	T _{OHSTL_III}	-0.17	-0.17	-0.19	ns
HSTL, Class IV	HSTL_IV	T _{OHSTL_IV}	-0.40	-0.41	-0.45	ns
HSTL, Class I, 1.8V	HSTL_I_18	T _{OHSTL_I_18}	0.03	0.03	0.04	ns

Table 19: Output Delay Measurement Methodology

Description	IOSTANDARD Attribute	R _{REF} (Ω)	C _{REF} ⁽¹⁾ (pF)	V _{MEAS} (V)	V _{REF} (V)
SSTL (Stub Series Terminated Logic), Class I, 1.8V	SSTL18_I	50	0	V _{REF}	0.9
SSTL, Class II, 1.8V	SSTL18_II	25	0	V _{REF}	0.9
SSTL, Class I, 2.5V	SSTL2_I	50	0	V _{REF}	1.25
SSTL, Class II, 2.5V	SSTL2_II	25	0	V _{REF}	1.25
SSTL, Class I, 3.3V	SSTL3_I	50	0	V _{REF}	1.5
SSTL, Class II, 3.3V	SSTL3_II	25	0	V _{REF}	1.5
AGP-2X/AGP (Accelerated Graphics Port)	AGP-2X/AGP (rising edge)	50	0	0.94	0
	AGP-2X/AGP (falling edge)	50	0	2.03	3.3
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	50	0	V _{REF}	1.2
LVDS, 3.3V	LVDSEXT_25	50	0	V _{REF}	1.2
LVDSEXT (LVDS Extended Mode), 2.5V	LVDS_33	50	0	V _{REF}	1.2
LVDSEXT, 3.3V	LVDSEXT_33	50	0	V _{REF}	1.2
BLVDS (Bus LVDS), 2.5V	BLVDS_25	1M	0	1.2	0
LDT (HyperTransport), 2.5V	LDT_25	50	0	V _{REF}	0.6
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	1M	0	1.23	0
LVDCI/HSLVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V	LVDCI_33, HSLVDCI_33	1M	0	1.65	0
LVDCI/HSLVDCI, 2.5V	LVDCI_25, HSLVDCI_25	1M	0	1.25	0
LVDCI/HSLVDCI, 1.8V	LVDCI_18, HSLVDCI_18	1M	0	0.9	0
LVDCI/HSLVDCI, 1.5V	LVDCI_15, HSLVDCI_15	1M	0	0.75	0
HSTL (High-Speed Transceiver Logic), Class I & II, with DCI	HSTL_I_DCI, HSTL_II_DCI	50	0	V _{REF}	0.75
HSTL, Class III & IV, with DCI	HSTL_III_DCI, HSTL_IV_DCI	50	0	0.9	1.5
HSTL, Class I & II, 1.8V, with DCI	HSTL_I_DCI_18, HSTL_II_DCI_18	50	0	V _{REF}	0.9
HSTL, Class III & IV, 1.8V, with DCI	HSTL_III_DCI_18, HSTL_IV_DCI_18	50	0	1.1	1.8
SSTL (Stub Series Termi.Logic), Class I & II, 1.8V, with DCI	SSTL18_I_DCI, SSTL18_II_DCI	50	0	V _{REF}	0.9
SSTL, Class I & II, 2.5V, with DCI	SSTL2_I_DCI, SSTL2_II_DCI	50	0	V _{REF}	1.25
SSTL, Class I & II, 3.3V, with DCI	SSTL3_I_DCI, SSTL3_II_DCI	50	0	V _{REF}	1.5
GTL (Gunning Transceiver Logic) with DCI	GTL_DCI	50	0	0.8	1.2
GTL Plus with DCI	GTL_P_DCI	50	0	1.0	1.5

Notes:

1. C_{REF} is the capacitance of the probe, nominally 0 pF.
2. Per PCI specifications.
3. Per PCI-X specifications.

JTAG Test Access Port Switching Characteristics

Characterization data for some of the most commonly requested timing parameters shown in Figure 6 is listed in Table 33.

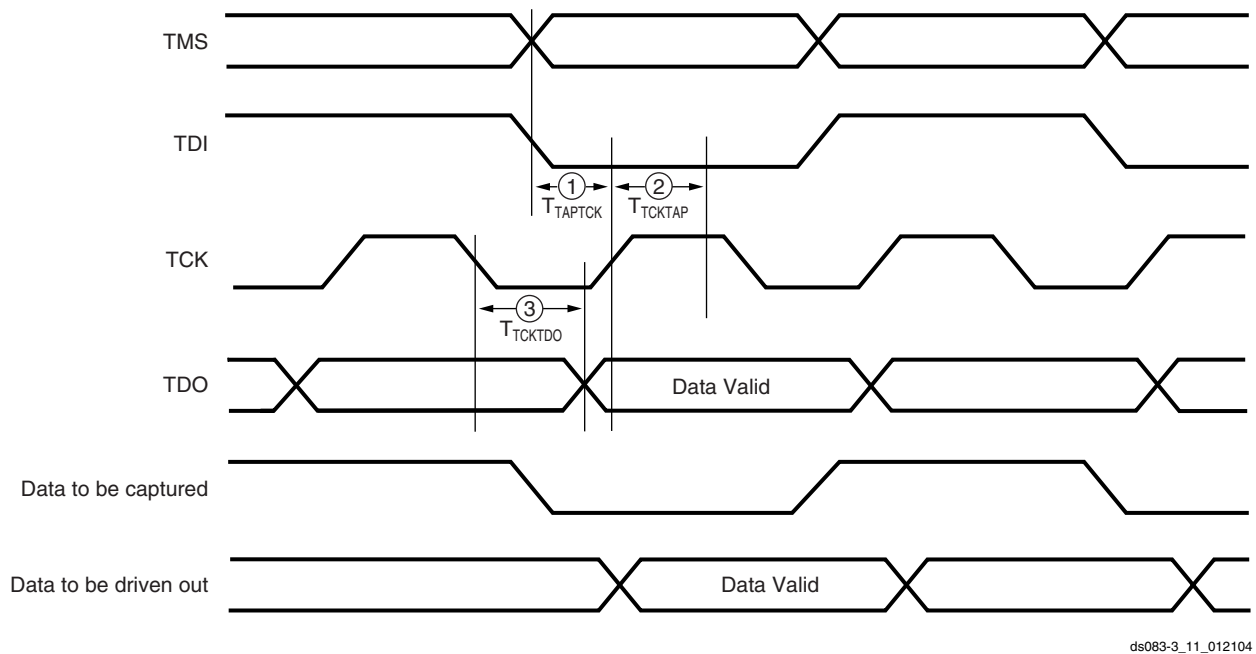


Figure 6: Virtex-II Pro Boundary Scan Port Timing Waveforms

Table 33: Boundary-Scan Port Timing Specifications

	Description	Figure References	Symbol	Value	Units
TCK	TMS and TDI setup time	1	T_{TAPTCK}	5.5	ns, min
	TMS and TDI hold times	2	T_{TCKTAP}	0.0	ns, min
	Falling edge to TDO output valid	3	T_{TCKTDO}	10.0	ns, max
	Maximum frequency		F_{TCK}	33.0	MHz, max

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
6	VCCO_6	J5		
7	VCCO_7	H6		
7	VCCO_7	H5		
7	VCCO_7	G6		
NA	CCLK	P15		
NA	PROG_B	A2		
NA	DONE	R14		
NA	M0	T2		
NA	M1	P2		
NA	M2	R3		
NA	HSWAP_EN	B3		
NA	TCK	A15		
NA	TDI	C2		
NA	TDO	C15		
NA	TMS	B14		
NA	PWRDWN_B	T15		
NA	RSVD	A4		
NA	RSVD	A3		
NA	VBATT	A14		
NA	RSVD	A13		
NA	VCCAUX	R16		
NA	VCCAUX	R1		
NA	VCCAUX	B16		
NA	VCCAUX	B1		
NA	VCCINT	N13		
NA	VCCINT	N4		
NA	VCCINT	M12		
NA	VCCINT	M5		
NA	VCCINT	E12		
NA	VCCINT	E5		
NA	VCCINT	D13		
NA	VCCINT	D4		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
1	IO_L92P_1	A15		
1	IO_L91N_1	B15		
1	IO_L91P_1/VREF_1	C15		
1	IO_L78N_1	D15	NC	
1	IO_L78P_1	E15	NC	
1	IO_L76N_1	F15	NC	
1	IO_L76P_1	G15	NC	
1	IO_L75N_1/VREF_1	G16	NC	
1	IO_L75P_1	F16	NC	
1	IO_L73N_1	A16	NC	
1	IO_L73P_1	A17	NC	
1	IO_L72N_1	B16		
1	IO_L72P_1	C16		
1	IO_L70N_1	D16		
1	IO_L70P_1	E16		
1	IO_L69N_1/VREF_1	C17		
1	IO_L69P_1	D17		
1	IO_L67N_1	H16		
1	IO_L67P_1	G17		
1	IO_L54N_1	E17		
1	IO_L54P_1	F17		
1	IO_L52N_1	A18		
1	IO_L52P_1	A19		
1	IO_L51N_1/VREF_1	E18		
1	IO_L51P_1	D18		
1	IO_L49N_1	B18		
1	IO_L49P_1	C18		
1	IO_L27N_1/VREF_1	F19	NC	NC
1	IO_L27P_1	F18	NC	NC
1	IO_L25N_1	G18	NC	NC
1	IO_L25P_1	G19	NC	NC
1	IO_L24N_1	B19		
1	IO_L24P_1	C19		
1	IO_L22N_1	D19		
1	IO_L22P_1	E19		
1	IO_L21N_1/VREF_1	A20		
1	IO_L21P_1	A21		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
4	IO_L78N_4	Y15	NC	
4	IO_L78P_4	AA15	NC	
4	IO_L91N_4/VREF_4	W15		
4	IO_L91P_4	W16		
4	IO_L92N_4	AB15		
4	IO_L92P_4	AC15		
4	IO_L93N_4	AD15		
4	IO_L93P_4	AE15		
4	IO_L94N_4/VREF_4	W14		
4	IO_L94P_4	Y14		
4	IO_L95N_4/GCLK3S	AA14		
4	IO_L95P_4/GCLK2P	AB14		
4	IO_L96N_4/GCLK1S	AC14		
4	IO_L96P_4/GCLK0P	AD14		
5	IO_L96N_5/GCLK7S	AC13		
5	IO_L96P_5/GCLK6P	AB13		
5	IO_L95N_5/GCLK5S	AA13		
5	IO_L95P_5/GCLK4P	Y13		
5	IO_L94N_5	W13		
5	IO_L94P_5/VREF_5	W12		
5	IO_L93N_5	AF15		
5	IO_L93P_5	AF14		
5	IO_L92N_5	AF13		
5	IO_L92P_5	AF12		
5	IO_L91N_5	AE12		
5	IO_L91P_5/VREF_5	AD12		
5	IO_L78N_5	AC12	NC	
5	IO_L78P_5	AB12	NC	
5	IO_L76N_5	AA12	NC	
5	IO_L76P_5	Y12	NC	
5	IO_L75N_5/VREF_5	AF11	NC	
5	IO_L75P_5	AF10	NC	
5	IO_L73N_5	AE11	NC	
5	IO_L73P_5	AD11	NC	
5	IO_L72N_5	AC11		
5	IO_L72P_5	AB11		

BG575/BGG575 Standard BGA Package

As shown in Table 9, XC2V1000, XC2V1500, and XC2V2000 Virtex-II devices are available in the BG575/BGG575 BGA package. Pins in the XC2V1000, XC2V1500, and XC2V2000 devices are the same, except for the pin differences in the XC2V1000 and XC2V1500 devices shown in the No Connect columns. Following this table are the **BG575/BGG575 Standard BGA Package Specifications (1.27mm pitch)**.

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
0	IO_L01N_0	A3		
0	IO_L01P_0	A4		
0	IO_L02N_0	D5		
0	IO_L02P_0	C5		
0	IO_L03N_0/VRP_0	E6		
0	IO_L03P_0/VRN_0	D6		
0	IO_L04N_0/VREF_0	F7		
0	IO_L04P_0	E7		
0	IO_L05N_0	G8		
0	IO_L05P_0	H9		
0	IO_L06N_0	A5		
0	IO_L06P_0	A6		
0	IO_L19N_0	B5		
0	IO_L19P_0	B6		
0	IO_L21N_0	D7		
0	IO_L21P_0/VREF_0	C7		
0	IO_L22N_0	F8		
0	IO_L22P_0	E8		
0	IO_L24N_0	G9		
0	IO_L24P_0	F9		
0	IO_L49N_0	G10		
0	IO_L49P_0	H10		
0	IO_L51N_0	B7		
0	IO_L51P_0/VREF_0	B8		
0	IO_L52N_0	D8		
0	IO_L52P_0	C8		
0	IO_L54N_0	E9		
0	IO_L54P_0	D9		
0	IO_L67N_0	A8	NC	
0	IO_L67P_0	A9	NC	
0	IO_L69N_0	C9	NC	

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
5	IO_L52N_5	AA9		
5	IO_L52P_5	Y9		
5	IO_L51N_5/VREF_5	W9		
5	IO_L51P_5	V9		
5	IO_L49N_5	AD8		
5	IO_L49P_5	AD6		
5	IO_L24N_5	AC8		
5	IO_L24P_5	AC7		
5	IO_L22N_5	AB8		
5	IO_L22P_5	AA8		
5	IO_L21N_5/VREF_5	W8		
5	IO_L21P_5	Y8		
5	IO_L19N_5	AD5		
5	IO_L19P_5	AD4		
5	IO_L06N_5	AC6		
5	IO_L06P_5	AC5		
5	IO_L05N_5/VRP_5	AB7		
5	IO_L05P_5/VRN_5	AA7		
5	IO_L04N_5	AB5		
5	IO_L04P_5/VREF_5	AA5		
5	IO_L03N_5/D4/ALT_VRP_5	AA6		
5	IO_L03P_5/D5/ALT_VRN_5	Y6		
5	IO_L02N_5/D6	Y7		
5	IO_L02P_5/D7	W7		
5	IO_L01N_5/RDWR_B	V8		
5	IO_L01P_5/CS_B	U9		
6	IO_L01P_6	AB2		
6	IO_L01N_6	AB1		
6	IO_L02P_6/VRN_6	AA3		
6	IO_L02N_6/VRP_6	AA2		
6	IO_L03P_6	Y4		
6	IO_L03N_6/VREF_6	Y3		
6	IO_L04P_6	W4		
6	IO_L04N_6	W5		
6	IO_L06P_6	V5		

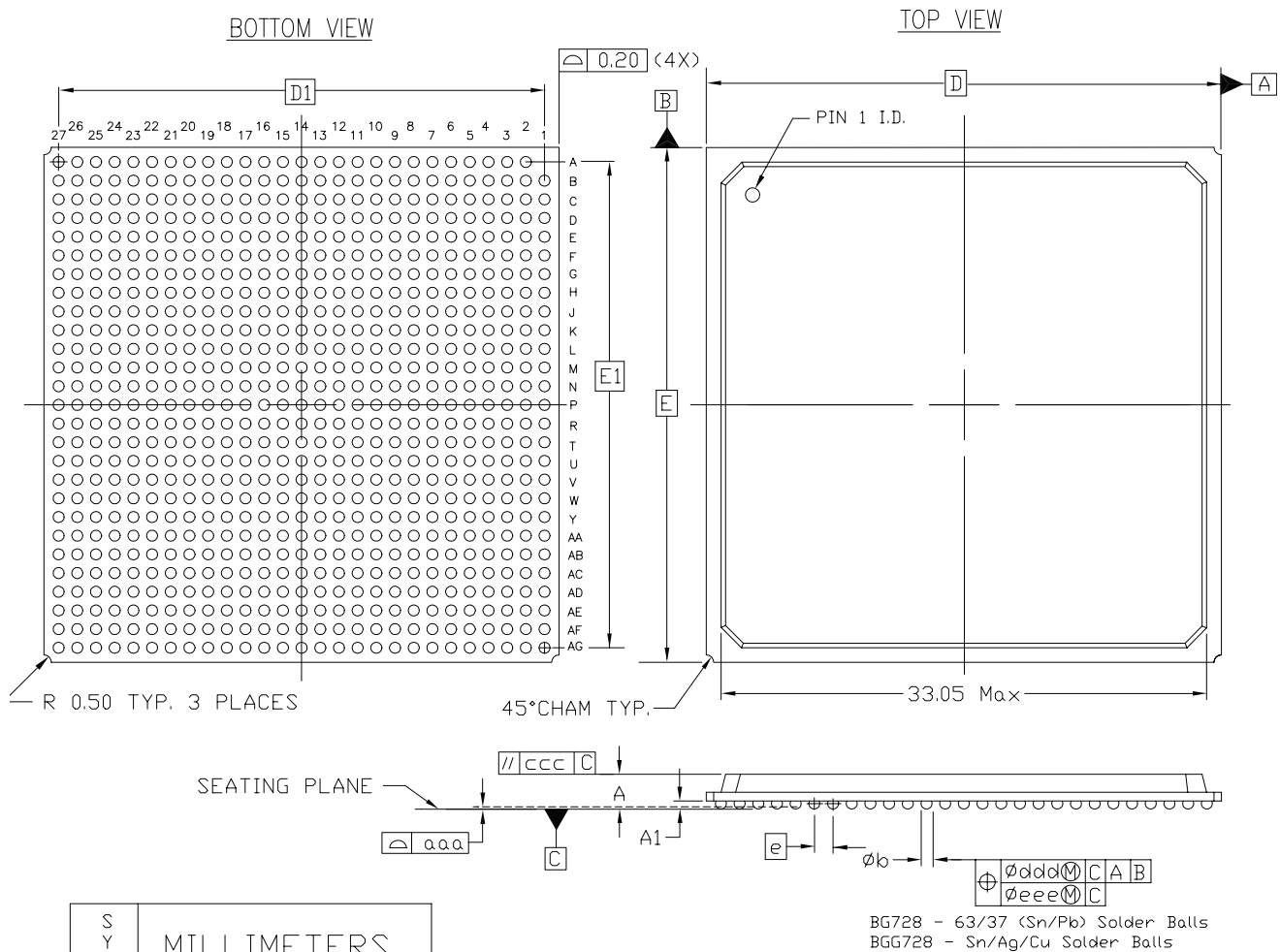
Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
NA	VCCINT	R10		
NA	VCCINT	P15		
NA	VCCINT	P10		
NA	VCCINT	N15		
NA	VCCINT	N10		
NA	VCCINT	M15		
NA	VCCINT	M10		
NA	VCCINT	L15		
NA	VCCINT	L10		
NA	VCCINT	K15		
NA	VCCINT	K14		
NA	VCCINT	K13		
NA	VCCINT	K12		
NA	VCCINT	K11		
NA	VCCINT	K10		
NA	VCCINT	J16		
NA	VCCINT	J9		
NA	VCCINT	H17		
NA	VCCINT	H8		
NA	GND	AD24		
NA	GND	AD23		
NA	GND	AD18		
NA	GND	AD7		
NA	GND	AD2		
NA	GND	AD1		
NA	GND	AC24		
NA	GND	AC23		
NA	GND	AC2		
NA	GND	AC1		
NA	GND	AB22		
NA	GND	AB3		
NA	GND	AA21		
NA	GND	AA15		
NA	GND	AA10		
NA	GND	AA4		
NA	GND	Y20		

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
2	IO_L70P_2	N19
2	IO_L72N_2	M22
2	IO_L72P_2	M23
2	IO_L73N_2	M24
2	IO_L73P_2	N24
2	IO_L75N_2	M26
2	IO_L75P_2/VREF_2	M27
2	IO_L76N_2	N20
2	IO_L76P_2	N21
2	IO_L78N_2	N22
2	IO_L78P_2	N23
2	IO_L91N_2	N25
2	IO_L91P_2	P25
2	IO_L93N_2	N26
2	IO_L93P_2/VREF_2	N27
2	IO_L94N_2	P20
2	IO_L94P_2	P21
2	IO_L96N_2	P22
2	IO_L96P_2	P23
3	IO_L96N_3	R27
3	IO_L96P_3	R26
3	IO_L94N_3	R25
3	IO_L94P_3	R24
3	IO_L93N_3/VREF_3	R23
3	IO_L93P_3	T23
3	IO_L91N_3	R22
3	IO_L91P_3	R21
3	IO_L78N_3	R20
3	IO_L78P_3	R19
3	IO_L76N_3	T27
3	IO_L76P_3	T26
3	IO_L75N_3/VREF_3	T24
3	IO_L75P_3	U24
3	IO_L73N_3	T22
3	IO_L73P_3	U22

BG728/BGG728 Standard BGA Package Specifications (1.27mm pitch)



NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1994
2. SYMBOL 'M' IS THE BALL MATRIX SIZE.
3. CONFORMS TO JEDEC MS-034-BAR-1
4. NO SOLDER BALL AND LAND ON A1.

728-BALL MOLDED BGA (BG728/BGG728)

Figure 6: BG728/BGG728 Standard BGA Package Specifications

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
2	IO_L51N_2	L6	
2	IO_L51P_2/VREF_2	M6	
2	IO_L52N_2	M3	
2	IO_L52P_2	L3	
2	IO_L53N_2	L4	
2	IO_L53P_2	K4	
2	IO_L54N_2	N4	
2	IO_L54P_2	M4	
2	IO_L67N_2	M2	
2	IO_L67P_2	L2	
2	IO_L68N_2	N8	
2	IO_L68P_2	P8	
2	IO_L69N_2	N6	
2	IO_L69P_2/VREF_2	P6	
2	IO_L70N_2	P5	
2	IO_L70P_2	N5	
2	IO_L71N_2	P10	
2	IO_L71P_2	R10	
2	IO_L72N_2	P3	
2	IO_L72P_2	N3	
2	IO_L73N_2	M1	
2	IO_L73P_2	L1	
2	IO_L74N_2	P9	
2	IO_L74P_2	R9	
2	IO_L75N_2	P2	
2	IO_L75P_2/VREF_2	N2	
2	IO_L76N_2	R4	
2	IO_L76P_2	P4	
2	IO_L77N_2	R8	
2	IO_L77P_2	T8	
2	IO_L78N_2	T3	
2	IO_L78P_2	R3	
2	IO_L79N_2	P1	NC
2	IO_L79P_2	N1	NC
2	IO_L80N_2	T11	NC
2	IO_L80P_2	U11	NC

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
6	IO_L29P_6	AF31	
6	IO_L29N_6	AG31	
6	IO_L30P_6	AF32	
6	IO_L30N_6	AG32	
6	IO_L43P_6	AC25	
6	IO_L43N_6	AB25	
6	IO_L44P_6	AJ33	
6	IO_L44N_6	AH33	
6	IO_L45P_6	AE31	
6	IO_L45N_6/VREF_6	AD32	
6	IO_L46P_6	AD27	
6	IO_L46N_6	AC27	
6	IO_L47P_6	AJ34	
6	IO_L47N_6	AH34	
6	IO_L48P_6	AE30	
6	IO_L48N_6	AD30	
6	IO_L49P_6	AC26	
6	IO_L49N_6	AB26	
6	IO_L50P_6	AD29	
6	IO_L50N_6	AC29	
6	IO_L51P_6	AF33	
6	IO_L51N_6/VREF_6	AG33	
6	IO_L52P_6	AC28	
6	IO_L52N_6	AB28	
6	IO_L53P_6	AF34	
6	IO_L53N_6	AE33	
6	IO_L54P_6	AB27	
6	IO_L54N_6	AA27	
6	IO_L67P_6	AA25	
6	IO_L67N_6	Y25	
6	IO_L68P_6	AD33	
6	IO_L68N_6	AC33	
6	IO_L69P_6	AC32	
6	IO_L69N_6/VREF_6	AB32	
6	IO_L70P_6	AA26	
6	IO_L70N_6	Y26	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
6	IO_L71P_6	AD34	
6	IO_L71N_6	AC34	
6	IO_L72P_6	AC31	
6	IO_L72N_6	AD31	
6	IO_L73P_6	Y27	
6	IO_L73N_6	W27	
6	IO_L74P_6	AB29	
6	IO_L74N_6	AA29	
6	IO_L75P_6	AB31	
6	IO_L75N_6/VREF_6	AA31	
6	IO_L76P_6	Y28	
6	IO_L76N_6	Y29	
6	IO_L77P_6	AB33	
6	IO_L77N_6	AA33	
6	IO_L78P_6	AA30	
6	IO_L78N_6	AB30	
6	IO_L79P_6	W24	NC
6	IO_L79N_6	V24	NC
6	IO_L80P_6	AB34	NC
6	IO_L80N_6	AA34	NC
6	IO_L81P_6	W33	NC
6	IO_L81N_6/VREF_6	Y34	NC
6	IO_L82P_6	W25	NC
6	IO_L82N_6	V25	NC
6	IO_L83P_6	Y32	NC
6	IO_L83N_6	AA32	NC
6	IO_L84P_6	W29	NC
6	IO_L84N_6	V29	NC
6	IO_L91P_6	W28	
6	IO_L91N_6	V28	
6	IO_L92P_6	V33	
6	IO_L92N_6	V34	
6	IO_L93P_6	Y31	
6	IO_L93N_6/VREF_6	W31	
6	IO_L94P_6	V26	
6	IO_L94N_6	V27	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
0	IO_L22P_0	A34		
0	IO_L23N_0	K27		
0	IO_L23P_0	K26		
0	IO_L24N_0	F29		
0	IO_L24P_0	F30		
0	IO_L25N_0	B32		
0	IO_L25P_0	B33		
0	IO_L26N_0	L26		
0	IO_L26P_0	L25		
0	IO_L27N_0	G28		
0	IO_L27P_0/VREF_0	G29		
0	IO_L28N_0	C30		
0	IO_L28P_0	C31		
0	IO_L29N_0	J27		
0	IO_L29P_0	J26		
0	IO_L30N_0	D30		
0	IO_L30P_0	D31		
0	IO_L31N_0	A31	NC	
0	IO_L31P_0	A32	NC	
0	IO_L32N_0	H27	NC	
0	IO_L32P_0	H26	NC	
0	IO_L33N_0	F27	NC	
0	IO_L33P_0/VREF_0	F28	NC	
0	IO_L34N_0	B30	NC	
0	IO_L34P_0	B31	NC	
0	IO_L35N_0	M24	NC	
0	IO_L35P_0	M23	NC	
0	IO_L36N_0	D28	NC	
0	IO_L36P_0	D29	NC	
0	IO_L49N_0	C28		
0	IO_L49P_0	C29		
0	IO_L50N_0	K25		
0	IO_L50P_0	L24		
0	IO_L51N_0	E27		
0	IO_L51P_0/VREF_0	E28		
0	IO_L52N_0	A29		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
4	IO_L08P_4	AL12	NC	
4	IO_L09N_4	AP9	NC	
4	IO_L09P_4/VREF_4	AP8	NC	
4	IO_L10N_4	AV6	NC	
4	IO_L10P_4	AV5	NC	
4	IO_L11N_4	AM11	NC	
4	IO_L11P_4	AM12	NC	
4	IO_L12N_4	AN10	NC	
4	IO_L12P_4	AN9	NC	
4	IO_L19N_4	AU8		
4	IO_L19P_4	AU7		
4	IO_L20N_4	AH14		
4	IO_L20P_4	AH15		
4	IO_L21N_4	AT8		
4	IO_L21P_4/VREF_4	AT7		
4	IO_L22N_4	AW7		
4	IO_L22P_4	AW6		
4	IO_L23N_4	AK13		
4	IO_L23P_4	AK14		
4	IO_L24N_4	AR10		
4	IO_L24P_4	AR9		
4	IO_L25N_4	AV8		
4	IO_L25P_4	AV7		
4	IO_L26N_4	AJ14		
4	IO_L26P_4	AJ15		
4	IO_L27N_4	AP11		
4	IO_L27P_4/VREF_4	AP10		
4	IO_L28N_4	AU10		
4	IO_L28P_4	AU9		
4	IO_L29N_4	AL13		
4	IO_L29P_4	AL14		
4	IO_L30N_4	AN12		
4	IO_L30P_4	AN11		
4	IO_L31N_4	AW9	NC	
4	IO_L31P_4	AW8	NC	
4	IO_L32N_4	AM13	NC	